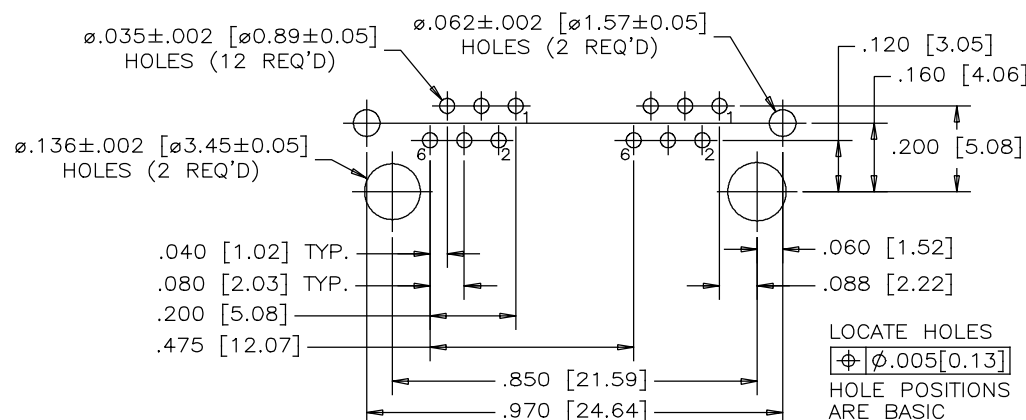
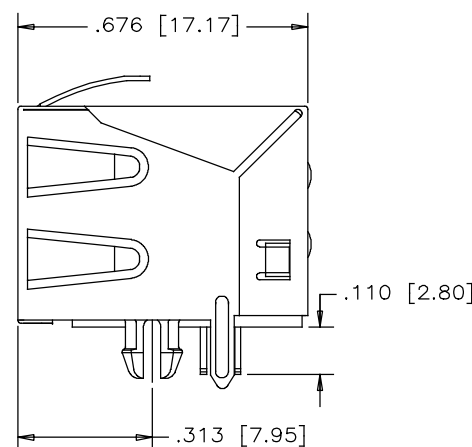
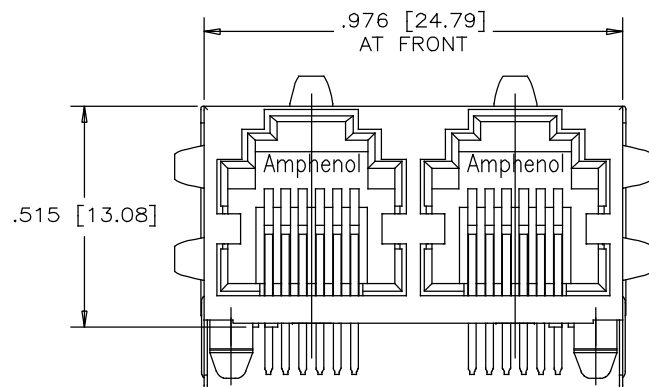
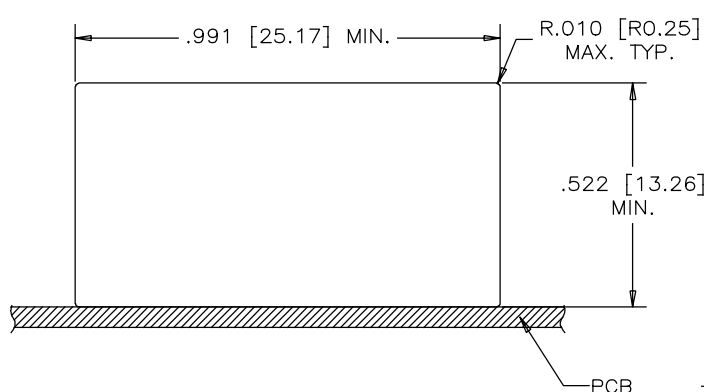


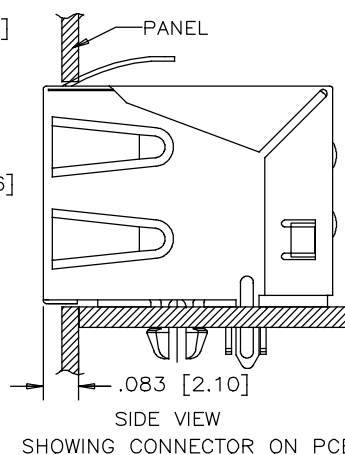
G		H	
REVISIONS			
REV	DESCRIPTION, ECN, EAR NO.	DATE	APP'D
A	PROPOSAL DRAWING	OCT08/14	L.CHAN
B	PROPOSAL DRAWING	FEB04/16	L.CHAN
C	PROPOSAL DRAWING	APR05/16	L.CHAN



RECOMMENDED P.C.B. LAYOUT
(COMPONENT SIDE OF BOARD)



RECOMMENDED PANEL CUTOUT



SIDE VIEW
SHOWING CONNECTOR ON PCB

MATERIALS:

PLASTIC HOUSING: HIGH TEMPERATURE RESISTANT NYLON
UL FLAMMABILITY RATING 94V-0.
SOLDER REFLOW PROCESS COMPATIBLE.

CONTACTS: PHOSPHOR BRONZE

CONTACT PLATING: GOLD PLATED ON MATING SURFACES.
(SEE PART NO. FOR THICKNESS).
50 MICROINCHES [1.27 MICRONS] MIN.
NICKEL UNDERPLATE
100 MICROINCHES [2.54 MICRONS] MIN.
MATTE TIN ON CONTACT TAILS.

SHIELD: COPPER ALLOY; NICKEL PLATED WITH TIN DIPPED
PCB TAILS.

RECOMMENDED SOLDERING TEMPERATURE:
WAVE SOLDERING OR REFLOW SOLDERING AT 260°C
MAXIMUM FOR 5 SEC MAXIMUM.

AMPHENOL PART NUMBER: RJE01-X62-02

GOLD PLATING:
1=RJ45 CONTACT 6u"
G=RJ45 CONTACT 15u"
J=RJ45 CONTACT 30u"
6=RJ45 CONTACT 50u"

UNLESS SPECIFIED OTHERWISE		DRAWN	F.WANG	OCT08/14	Amphenol Canada Corp. www.amphenolcanada.com	
PRIMARY UNITS	INCHES	CHECKED	L.Chan	OCT08/14		
SECONDARY	MILLIMETERS	M.E. APP'D				
REFERENCE IN PARENTHESES		Q.A. APP'D				
GENERAL TOLERANCES FOR MM		DWG APP'D			HIGH SPEED MODULAR JACK, 2 PORT, 6 POSITION, 6 CONTACTS, SHIELD WITH PCB TAILS-RoHS COMPLIANT	
1 DECIMAL PLACE	±0.025	ENG. REL. NO.				
2 DECIMAL PLACE	±0.020	REF.				
3 DECIMAL PLACE	±0.015					
ANGULAR DEGREES	±1.5°	THIRD ANGLE PROJECTION			DWG NO. P-RJE01-X62-02	
		DO NOT SCALE DRAWING			REV C	
					CODE ID NO. 03554	DWG SIZE: C
					SCALE: N/A	SHEET 1 OF 1

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